

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: IDH08G120C5XKSA1
Manufacturer: Infineon Technologies
Package: TO-220-2
Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/infineon-technologies/idh08g120c5ksa1.html>

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New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

Diode

Silicon Carbide Schottky Diode

IDH08G120C5

5th Generation CoolSiC™ 1200 V SiC Schottky Diode

Final Datasheet

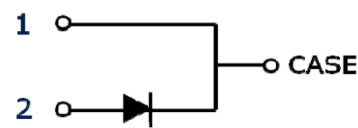
Rev. 2.2 2021-03-01

Industrial Power Control

CoolSiC™ SiC Schottky Diode

Features:

- Revolutionary semiconductor material - Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant



Benefits

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: www.infineon.com/sic



Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

Package pin definitions

- Pin 1 and backside – cathode
- Pin 2 – anode



Key Performance and Package Parameters

Type	V _{DC}	I _F	Q _C	T _{j,max}	Marking	Package
IDH08G120C5	1200V	8A	28nC	175°C	D0812C5	PG-TO220-2-1

1) J-STD20 and JESD22

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Maximum ratings

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	1200	V
Continuous forward current for $R_{th(j-c,max)}$ $T_C = 151^{\circ}C$, $D=1$ $T_C = 135^{\circ}C$, $D=1$ $T_C = 25^{\circ}C$, $D=1$	I_F	8.0 11.0 22.8	A
Surge non-repetitive forward current, sine halfwave $T_C=25^{\circ}C$, $t_p=10ms$ $T_C=150^{\circ}C$, $t_p=10ms$	$I_{F,SM}$	70 60	A
Non-repetitive peak forward current $T_C = 25^{\circ}C$, $t_p=10 \mu s$	$I_{F,max}$	530	A
i^2t value $T_C = 25^{\circ}C$, $t_p=10 ms$ $T_C = 150^{\circ}C$, $t_p=10 ms$	$\int i^2 dt$	25 18	A ² s
Diode dv/dt ruggedness $V_R=0...960V$	dv/dt	150	V/ns
Power dissipation $T_C = 25^{\circ}C$	P_{tot}	126	W
Operating temperature	T_j	-55...175	$^{\circ}C$
Storage temperature	T_{stg}	-55...150	$^{\circ}C$
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T_{sold}	260	$^{\circ}C$
Mounting torque M3 and M4 screws	M	0.7	Nm

Thermal Resistances

Thermal Resistances						
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Characteristic						
Diode thermal resistance, junction – case	R _{th(j-c)}		-	0.92	1.19	K/W
Thermal resistance, junction – ambient	R _{th(j-a)}	leaded	-	-	62	K/W

Electrical Characteristics

Static Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
DC blocking voltage	V _{DC}	T _j = 25°C	1200	-	-	V
Diode forward voltage	V _F	I _F = 8A, T _j =25°C	-	1.65	1.95	V
		I _F = 8A, T _j =150°C	-	2.25	2.85	
Reverse current	I _R	V _R =1200V, T _j =25°C		3	40	μA
		V _R =1200V, T _j =150°C		14	210	

Dynamic Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristics						
Total capacitive charge	Q_C	$V_R=800V, T_j=150^{\circ}C$ $Q_C = \int_0^{V_R} C(V)dV$	-	28	-	nC
Total Capacitance	C	$V_R=1\text{ V}, f=1\text{ MHz}$	-	365	-	pF
		$V_R=400\text{ V}, f=1\text{ MHz}$	-	26	-	
		$V_R=800\text{ V}, f=1\text{ MHz}$	-	20	-	

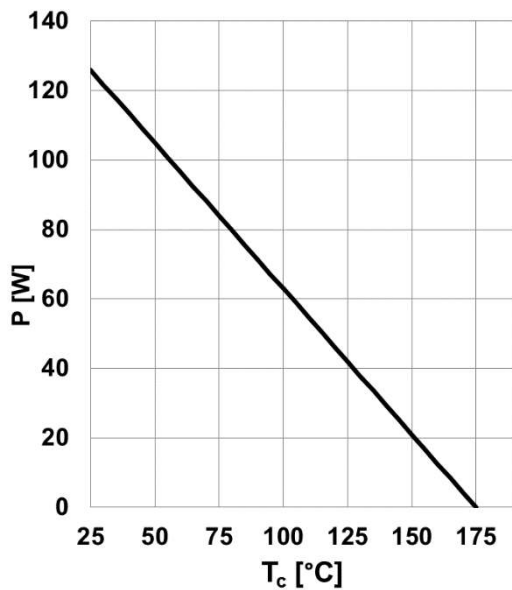


Figure 1. Power dissipation as a function of case temperature, $P_{tot}=f(T_c)$, $R_{th(j-c),max}$

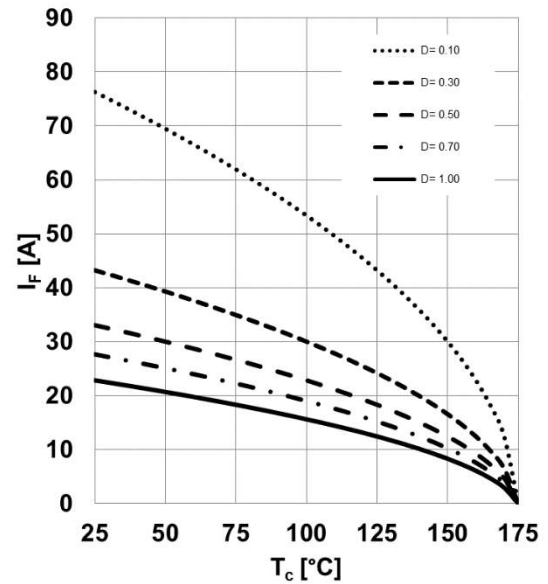


Figure 2. Diode forward current as function of temperature, $T_j \leq 175^\circ\text{C}$, $R_{th(j-c),max}$, parameter D =duty cycle, V_{th} , R_{diff} @ $T_j=175^\circ\text{C}$

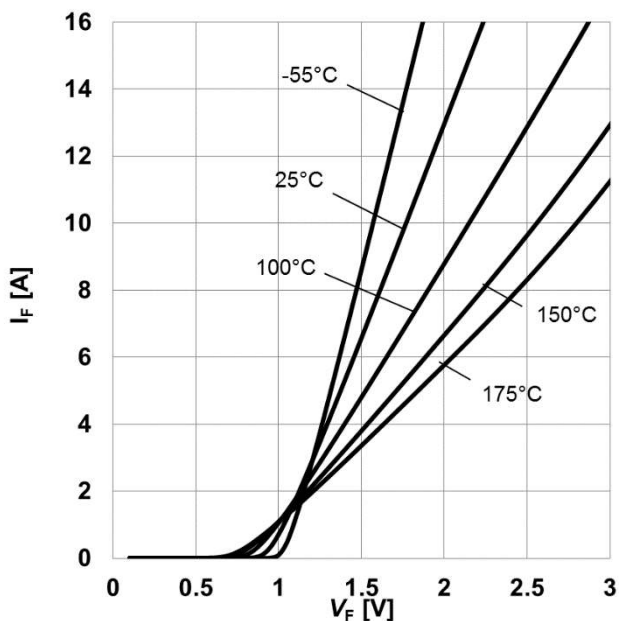


Figure 3. Typical forward characteristics, $I_F=f(V_F)$, $t_p=10\text{ }\mu\text{s}$, parameter: T_j

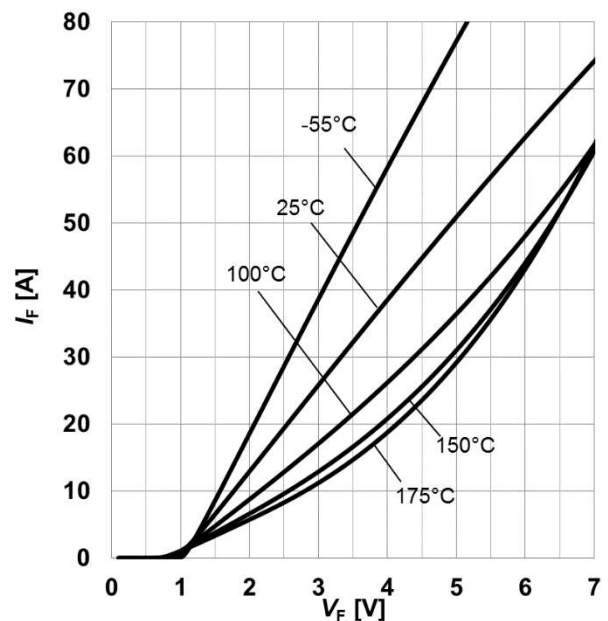


Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10\text{ }\mu\text{s}$, parameter: T_j

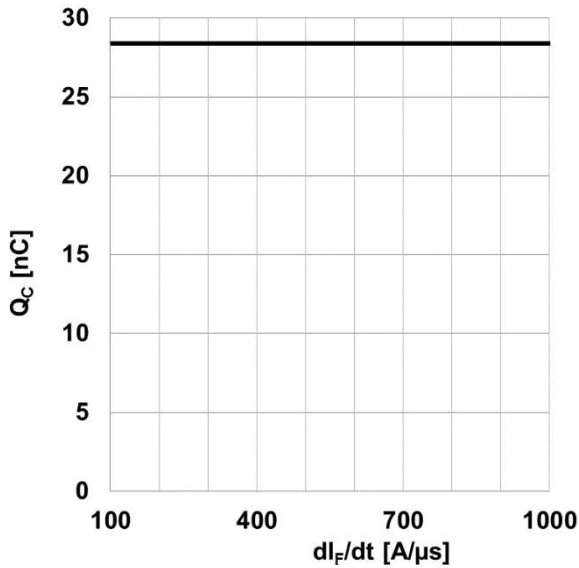


Figure 5. **Typical capacitive charge as function of current slope¹**, $Q_C=f(dI_F/dt)$, $T_J=150^{\circ}\text{C}$
1) Only capacitive charge, guaranteed by design.

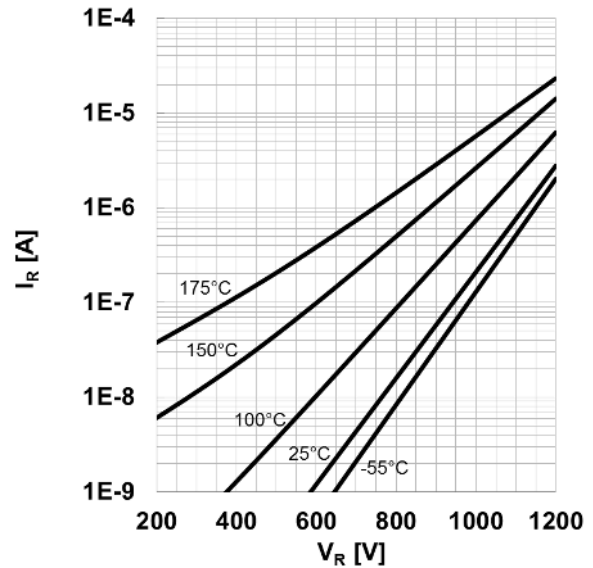


Figure 6. **Typical reverse current as function of reverse voltage**, $I_R=f(V_R)$, parameter: T_J

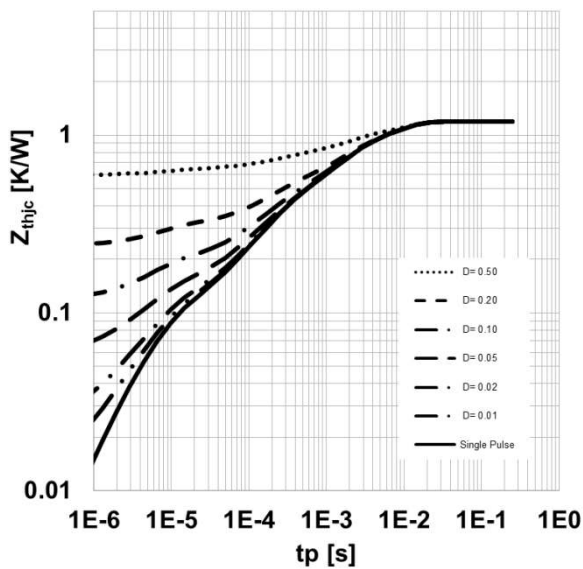


Figure 7. **Max. transient thermal impedance**, $Z_{th,jc}=f(t_p)$, parameter: $D=t_p/T$

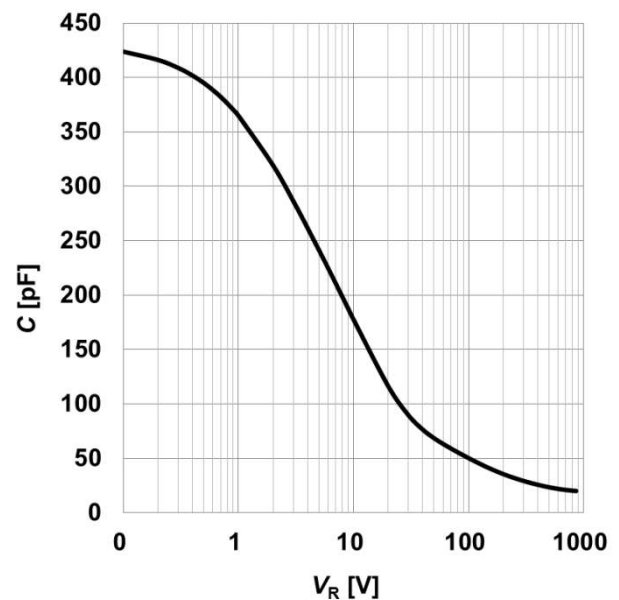


Figure 8. **Typical capacitance as function of reverse voltage**, $C=f(V_R)$; $T_J=25^{\circ}\text{C}$; $f=1\text{ MHz}$

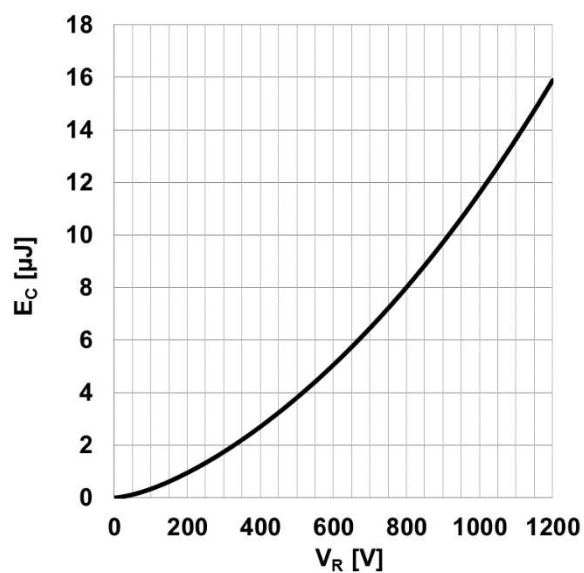
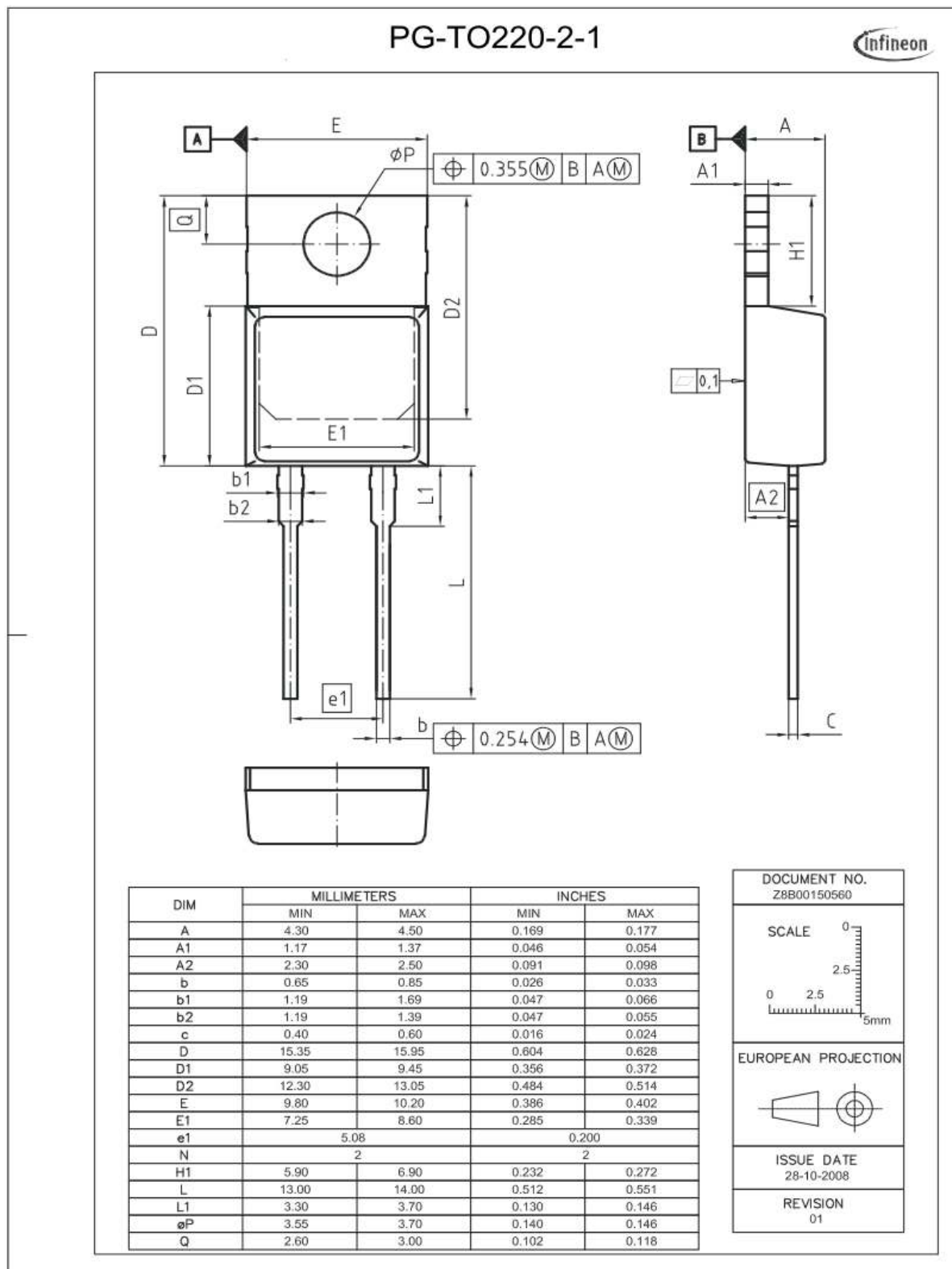


Figure 9. **Typical capacitively stored energy as function of reverse voltage,**

$$E_C = \int_0^{V_R} C(V)VdV$$



Revision HistoryIDH08G120C5

Revision: 2021-03-01, Rev. 2.2

Previous Revision:

Revision	Date	Subjects (major changes since last version)
2.0	2015-07-22	Final data sheet
2.1	2017-07-21	Editorial Changes
2.2	2021-03-01	Increased dv/dt ruggedness

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